COMPLIANT

HALOGEN FREE

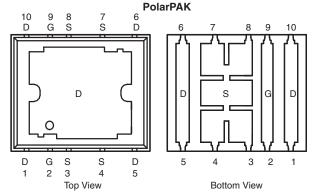


Vishay Siliconix

N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY								
		I _D (A) ^a					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	Silicon Limit	Package Limit	Q _g (Typ.)				
25	$0.0014 \text{ at V}_{GS} = 10 \text{ V}$	229	60	46 nC				
25	0.0018 at $V_{GS} = 4.5 \text{ V}$	202	60	40110				

Package Drawing www.vishay.com/doc?72945



Top surface is connected to pins 1, 5, 6, and 10

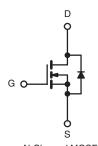
Ordering Information: SiE882DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Gen III Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size, ≤ 100 V
- Low Q_{qd}/Q_{qs} Ratio Helps Prevent Shoot-Through
- 100 % R_q and UIS Tested
- · Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- VRM
- · DC/DC Conversion: Low-Side
- Server Vcore



N-Channel MOSFET For Related Documents www.vishay.com/ppg?65002

ABSOLUTE MAXIMUM RATIN	GS T _A = 25 °C,	unless othe	erwise noted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	<u> </u>		25	V	
Gate-Source Voltage		V_{GS}	± 20	v	
	T _C = 25 °C		229 (Silicon Limit)		
	10 - 25 0		60 ^a (Package Limit)		
Continuous Drain Current ($T_J = 150 ^{\circ}\text{C}$)	T _C = 70 °C	I _D	60 ^a		
	T _A = 25 °C		47 ^{b, c}		
	T _A = 70 °C		41 ^{b, c}	Α	
Pulsed Drain Current	•	I _{DM}	100		
Continuous Source-Drain Diode Current	T _C = 25 °C		60 ^a		
Continuous Source-Diam Diode Current	T _A = 25 °C	I _S	4.3 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	50		
Avalanche Energy	L = U. I IIII	E _{AS}	125	mJ	
	T _C = 25 °C		125		
Maximum Power Dissipation	T _C = 70 °C	P _D	80	w	
Maximum Fower Dissipation	T _A = 25 °C	1 'D	5.2 ^{b, c}	v	
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to 150	- °C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260	7	

Notes:

- a. Package limited is 60 A.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATING	RESISTANCE RATINGS				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R_{thJA}	20	24	
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	0.8	1	°C/W
Maximum Junction-to-Case (Source) ^{a, c}	Steady State	R _{thJC} (Source)	2.2	2.7	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 $^{\circ}\text{C/W}.$
- c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static			•			
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		25		>//00
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = 250 μΑ		- 6.0		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.0	1.7	2.2	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	1	V _{DS} = 25 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α
	В	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.0011	0.0014	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0015	0.0018	Ω
Forward Transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$		125		S
Dynamic ^b						
Input Capacitance	C _{iss}			6400		
Output Capacitance	C _{oss}	$V_{DS} = 12.5 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1400		pF
Reverse Transfer Capacitance	C _{rss}			550		
Tatal Cata Chausa	0	$V_{DS} = 12.5 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		96	145	
Total Gate Charge	Qg			46	70	
Gate-Source Charge	Q_{gs}	$V_{DS} = 12.5 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		18		nC
Gate-Drain Charge	Q_{gd}			12		
Gate Resistance	R_q	f = 1 MHz	0.2	1.1	2.2	Ω
Turn-On Delay Time	t _{d(on)}			45	70	
Rise Time	ì,	$V_{DD} = 12.5 \text{ V}, R_{L} = 1.25 \Omega$		170	255	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		65	100	
Fall Time	ì, ′	· ·		85	130	
Turn-On Delay Time	t _{d(on)}			20	30	nc
Rise Time	ì,	$V_{DD} = 12.5 \text{ V}, R_{L} = 1.25 \Omega$		15	25	ns
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		45	70	1
Fall Time	ì _f ′	ŭ		10	15	
Drain-Source Body Diode Characteristic	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			60	۸
Pulse Diode Forward Current ^a	I _{SM}				100	Α
Body Diode Voltage	V_{SD}	I _S = 10 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	-		55	85	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1 10 A 41/44 100 A/44 T 05 00		70	105	nC
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		25		
Reverse Recovery Rise Time	t _b			30		ns

Notes:

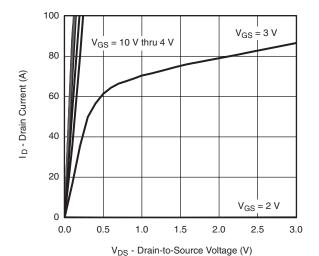
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

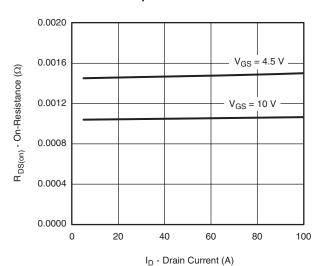


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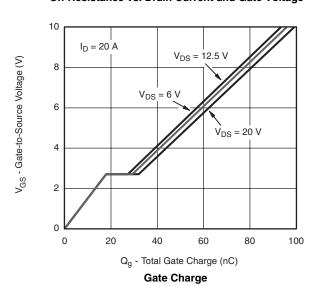
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

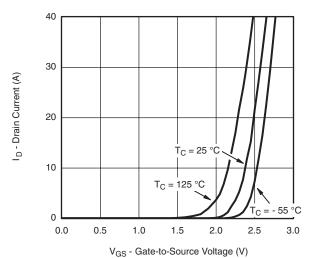


Output Characteristics

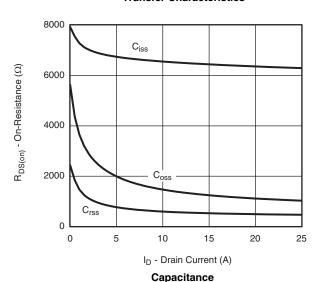


On-Resistance vs. Drain Current and Gate Voltage

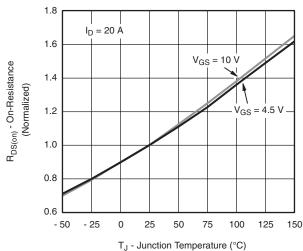




Transfer Characteristics



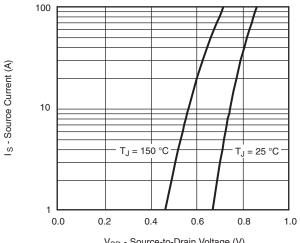
Сараспапсе

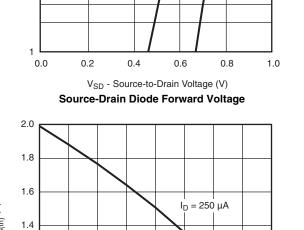


On-Resistance vs. Junction Temperature

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





T_J - Temperature (°C) **Threshold Voltage**

50

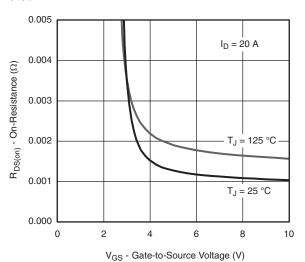
75

100

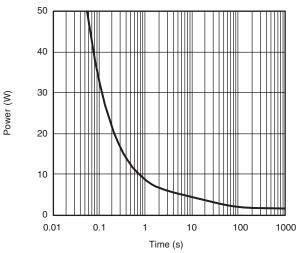
125

150

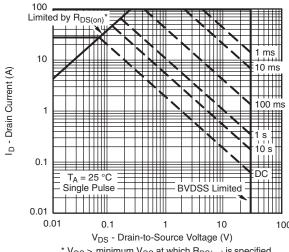
25



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



* $V_{GS} > \mbox{minimum } V_{GS}$ at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

1.2

1.0

8.0 - 50

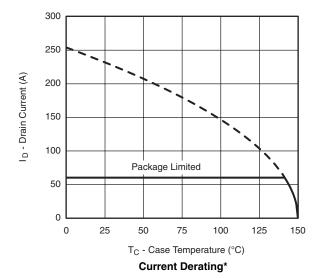
- 25

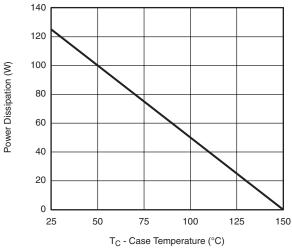
0



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





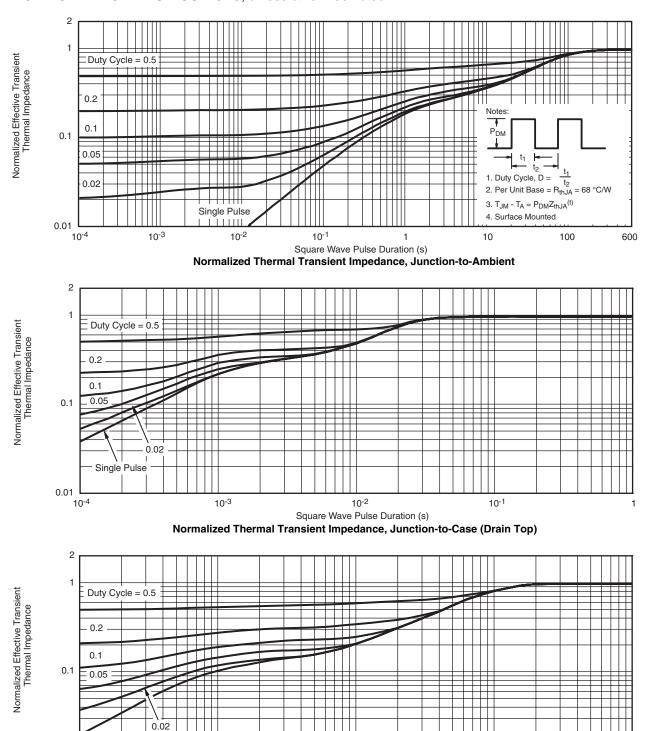
Power Derating, Junction-to-Case

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Source

10⁻²

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg265002.

Single Pulse

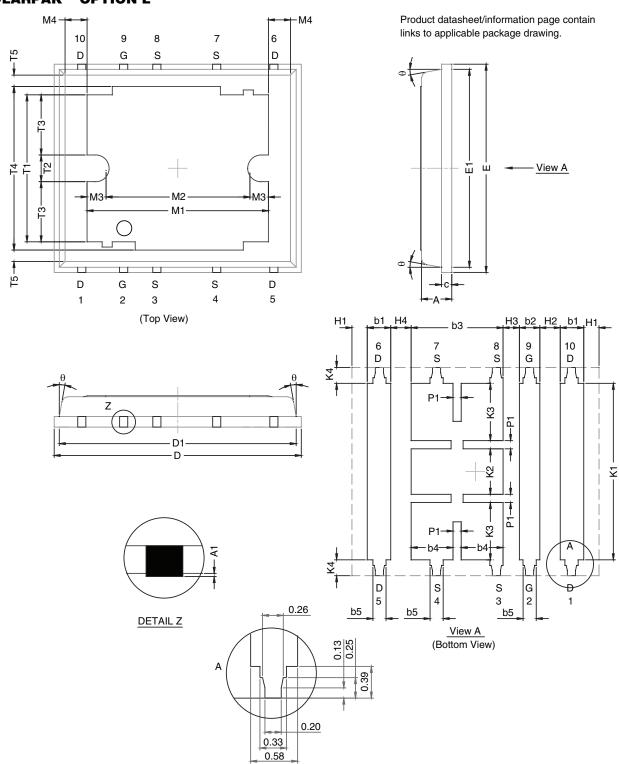
10⁻³

0.01 -



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POLARPAK™ OPTION L



Package Information

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DIM		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	0.75	0.80	0.85	0.030	0.031	0.033		
A1	0.00	-	0.05	0.000	-	0.002		
b1	0.48	0.58	0.68	0.019	0.023	0.027		
b2	0.41	0.51	0.61	0.016	0.020	0.024		
b3	2.19	2.29	2.39	0.086	0.090	0.094		
b4	0.89	1.04	1.19	0.035	0.041	0.047		
b5	0.23	0.33	0.43	0.009	0.013	0.017		
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	6.00	6.15	6.30	0.236	0.242	0.248		
D1	5.74	5.89	6.04	0.226	0.232	0.238		
E	5.01	5.16	5.31	0.197	0.203	0.209		
E1	4.75	4.90	5.05	0.187	0.193	0.199		
H1	0.23	-	-	0.009	-	-		
H2	0.45	-	0.56	0.018	-	0.022		
H3	0.31	0.41	0.51	0.012	0.016	0.020		
H4	0.45	-	0.56	0.018	-	0.022		
K1	4.22	4.37	4.52	0.166	0.172	0.178		
K2	1.08	1.13	1.18	0.043	0.044	0.046		
K3	1.37	-	-	0.054	-	-		
K4	0.24	-	-	0.009	-	-		
M1	4.30	4.50	4.70	0.169	0.177	0.185		
M2	3.43	3.58	3.73	0.135	0.141	0.147		
МЗ	0.22	-	-	0.009	-	-		
M4	0.05	-	-	0.002	-	-		
P1	0.15	0.20	0.25	0.006	0.008	0.010		
T1	3.48	3.64	4.10	0.137	0.143	0.161		
T2	0.56	0.76	0.95	0.022	0.030	0.037		
T3	1.20	-	-	0.047	-	=		
T4	3.90	-	-	0.153	-	-		
T5	0	0.18	0.36	0.000	0.007	0.014		
θ	0°	10°	12°	0°	10°	12°		

DWG: 5946

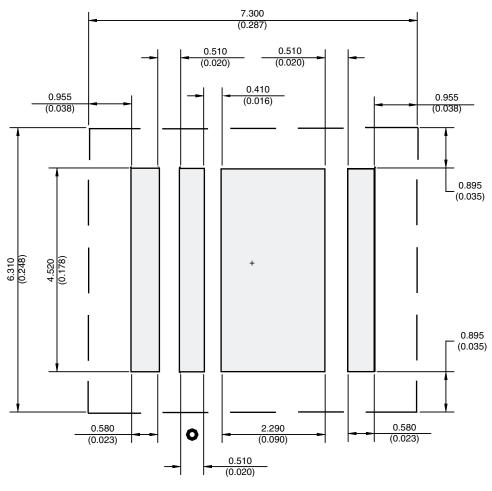
Notes

Millimeters govern over inches.

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR PolarPAK® Option L and S



Recommended Minimum for PolarPAK Option L and S Dimensions in mm/(Inches) No External Traces within Broken Lines Dot indicates Gate Pin (Part Marking)

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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000